

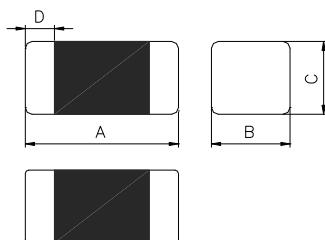
1. Features

- 1.Low DC resistance structure of electrode to prevent wasteful electric power consumption.
- 2.Suitable for reflow soldering.
- 3.Excellent solder ability and heat resistance.
- 4.100% Lead(Pb) & Halogen-Free and RoHS compliant.
- 5.Operating Temperature:-55~+105°C (Including self-temperature rise)



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2. Dimensions



Chip Size				
Series	A(mm)	B(mm)	C(mm)	D(mm)
160809	1.60±0.15	0.80±0.15	0.95 max.	0.30±0.20

3. Part Numbering

MPI **160809** **M** **F** - **1R0** **M** - **1A0**

A B C D E F G

A: Series
B: Dimension
C: Category Code
D: Material
E: Inductance
F: Inductance Tolerance
G: Rated Current

Lead Free Material
1R0=1.00uH
M=±20%

4. Specification

Tai-Tech Part Number	Inductance(uH)	Test Frequency (Hz)	Rated Current (mA) max.	DCR (Ω)	
				max.	typ.
MPI160809MF-1R0M-1A0	1.00±20%	1M / 60mV	1000	0.23	0.18
MPI160809MF-1R5M-0A8	1.50±20%	1M / 60mV	800	0.28	0.22
MPI160809MF-2R2M-0A7	2.20±20%	1M / 60mV	700	0.39	0.30
MPI160809MF-4R7M-0A5	4.70±20%	1M / 60mV	500	0.65	0.50

- Irms:DC current that causes temperature rise(ΔT 40°C) from 25°C ambient.